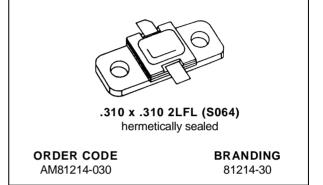


AM81214-030

RF & MICROWAVE TRANSISTORS L-BAND RADAR APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- RUGGEDIZED VSWR ∞:1
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- Pout = 26 W MIN. WITH 7.2 dB GAIN

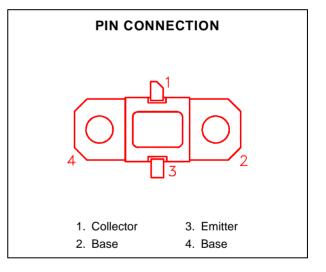


DESCRIPTION

The AM81214-030 device is a high power transistor specifically designed for L-Band Radar pulsed driver applications.

The device is capable of operation over a wide range of pulse widths, duty cycles and temperatures and is capable of withstanding ∞ :1 output VSWR at rated RF conditions. Low RF thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

The AM81214-030 is supplied in the IMPAC[™] Hermetic Metal/Ceramic package with internal Input/Output matching structures.



ABSOLUTE MAXIMUM RATINGS (Tcase = 25°C)

Symbol	Parameter	Value	Unit
P _{DISS}	Power Dissipation* $(T_C \le 100^{\circ}C)$	63	W
Ι _C	Device Current*	2.75	А
Vcc	Collector-Supply Voltage*	32	V
TJ	Junction Temperature (Pulsed RF Operation)	250	°C
T _{STG}	Storage Temperature	– 65 to +200	°C

THERMAL DATA

	R _{TH(j-c)}	Junction-Case Thermal Resistance*	2.4	°C/W
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*Applies only to rated RF amplifier operation

August	1992
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AM81214-030

ELECTRICAL SPECIFICATIONS $(T_{case} = 25^{\circ}C)$

STATIC

			Value			
Symbol		Test Conditions	Min.	Тур.	Max.	Unit
ВУсво	$I_C = 10 \text{mA}$	$I_E = 0mA$	55	—	—	V
BVEBO	$I_E = 1 m A$	$I_C = 0mA$	3.5			V
BVCER	IC = 20mA	$R_{BE} = 10\Omega$	55			V
ICES	$V_{BE} = 0V$	$V_{CE} = 28V$	_		5	mA
h _{FE}	$V_{CE} = 5V$	$I_{C} = 1A$	15	_	150	_

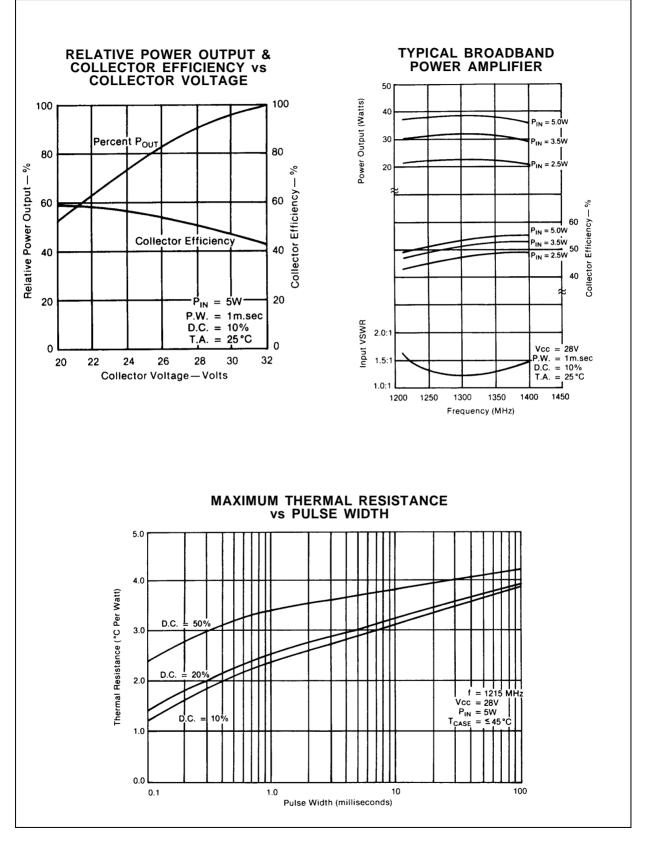
DYNAMIC

			Value			
Symbol	Test Conditions		Min.	Тур.	Max.	Unit
Pin	f = 1215 — 1400MHz P _{IN} = 5W Peak	$V_{CC} = 28V$	26	36		W
ηc	f = 1215 — 1400MHz P _{IN} = 5W Peak	$V_{CC} = 28V$	45	49	_	%
GP	f = 1215 — 1400MHz P _{IN} = 5W Peak	$V_{CC} = 28V$	7.2	8.5		dB

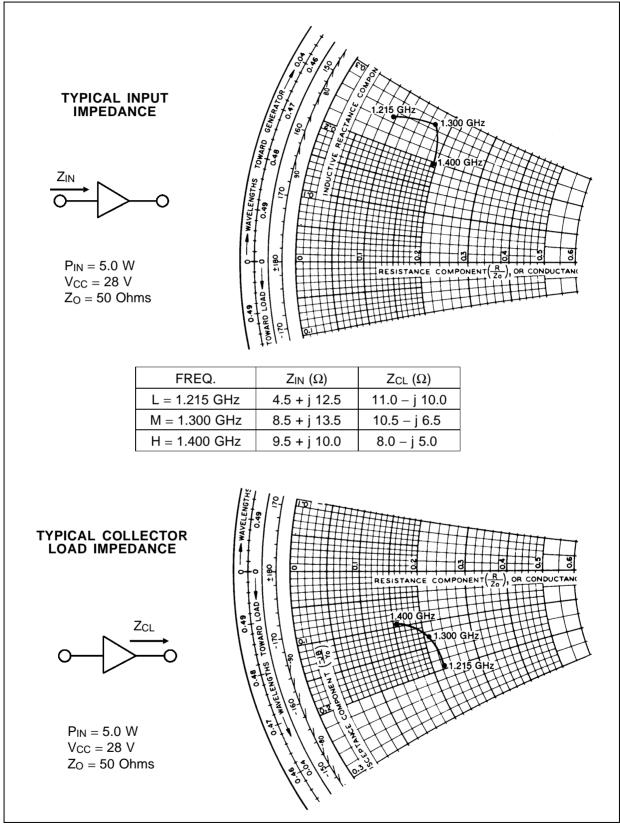
Note: Pulse Width = 1000μ S Duty Cycle = 10%



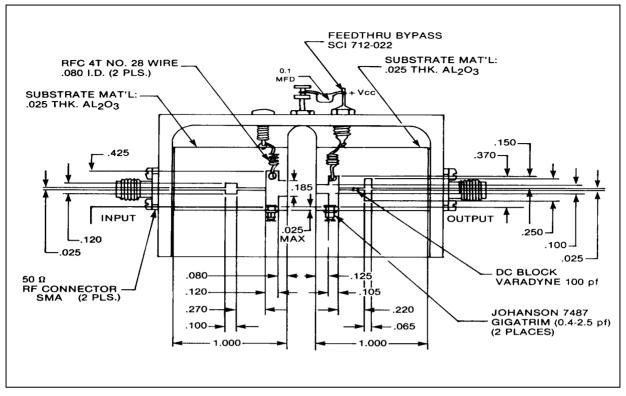
TYPICAL PERFORMANCE



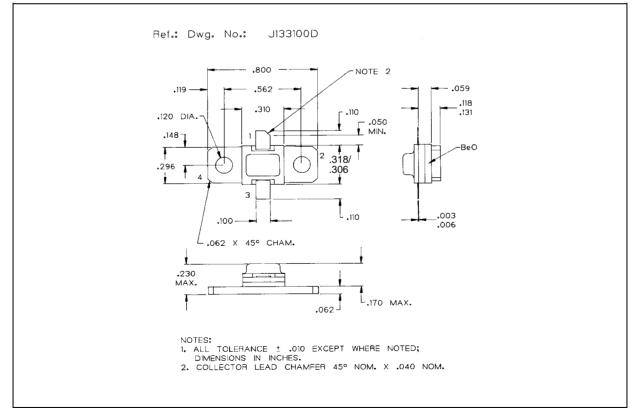
IMPEDANCE DATA



TEST CIRCUIT



PACKAGE MECHANICAL DATA





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